

Type	Hits	Search Text	DBs	Time Stamp
1 IS&R	1757	((257/347, 627, 521).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:15
2 BRS	596	((257/347, 627, 521).CCLS.) and (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:15
3 IS&R	1229	((257/622).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 10:45
4 BRS	1200	((257/622).CCLS.) not (((257/347, 627, 521).CCLS.) and (((257/347, 627, 521).CCLS.) and (wafer\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 10:45
5 BRS	296	((257/622).CCLS.) not (((257/347, 627, 521).CCLS.) and (((257/347, 627, 521).CCLS.) and (wafer\$1))) and (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 11:02
6 BRS	8805	(wafer\$1)and (orientation) and (crystal\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:27
7 BRS	8805	((wafer\$1)and (orientation) and (crystal\$1)) not (((257/347, 627, 521).CCLS.) and (((257/622).CCLS.) not (((257/347, 627, 521).CCLS.) and (((257/347, 627, 521).CCLS.) and (((257/347, 627, 521).CCLS.) and (wafer\$1))) and (wafer\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 11:03
8 BRS	2326	(semiconductor adj wafer\$1)and (orientation) and (crystal\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 11:03

Type	Hits	Search Text	DBs	Time Stamp
9	BRS 75	((semiconductor adj wafer\$1)and (orientation) and (crystal\$1)) not (((257/347,627,521).CCLS.) and (((257/622).CCLS.) not (((257/347,627,521).CCLS.) and (((257/347,627,521).CCLS.) and (wafer\$1)))) and (wafer\$1))) and (nick\$1 or notch\$2) and (crystal adj orientation\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:23
10	IS&R 1757	(257/347,627,521).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:16
11	BRS 596	((257/347,627,521).CCLS.) and (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:16
12	IS&R 0	("153 not 152").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:16
13	IS&R 388	(257/627).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:51
14	IS&R 1175	(438/149,479,517).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:53
15	BRS 426	((438/149,479,517).CCLS.) and (wafer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:53
16	BRS 390	((438/149,479,517).CCLS.) and (wafer\$1)) not ((257/347,627,521).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 13:54
17	BRS 2326	((semiconductor adj wafer\$1)and (orientation) and (crystal\$1)) not (((257/347,627,521).CCLS.) and (((257/622).CCLS.) not (((257/347,627,521).CCLS.) and (((257/347,627,521).CCLS.) and (wafer\$1)))) and (wafer\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/11 08:19

	Type	Hits	Search Text	DBs	Time Stamp
18	BRS	1	5060043.uref.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:32
19	BRS	3	5060043.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:32
20	BRS	3	5060043.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:43
21	BRS	1	"4783225".PN.	USPAT	2002/04/10 14:34
22	BRS	0	jp-90246505\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:44
23	BRS	2	jp-09246505\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:47
24	BRS	2	jp-08213578\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:48
25	BRS	136	kato-teruo\$.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/10 14:49
26	BRS	1	"5490811".PN.	USPAT	2002/04/11 08:16
27	BRS	104	yasue-takao\$.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/11 08:20